

Product Summary

B350AE/B360AE

V _{RRM} (V)	I _o (A)	V _F Max (V) @ +25°C	I _R Max (mA) @ +25°C
50	3	0.65	0.1
60	3	0.65	0.2

Features and Benefits

- Reduced Low Forward Voltage Drop (V_F); Better Efficiency and Cooler Operation
- Reduced High-Temperature Reverse Leakage; Increased Reliability against Thermal Runaway Failure in High Temperature Operation.
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](mailto:contact@diodes.com) or your local Diodes representative. <https://www.diodes.com/quality/product-definitions/>

Description and Applications

The Schottky rectifier providing low V_F and excellent reverse leakage stability at high temperatures, this device is ideal for use in general rectification applications such as:

- Boost Diode
- Blocking Diode
- Recirculating Diode

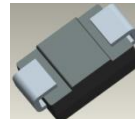
Mechanical Data

- Case: SMA
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (B3)
- Polarity: Cathode Band
- Weight: 0.063 grams (Approximate)

SMA



Top View



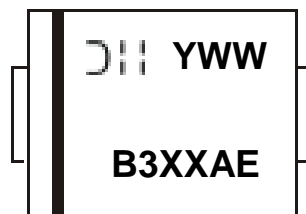
Bottom View

Ordering Information (Notes 4, 5)

Part Number	Case	Packaging	Status	Replacement
B350AE-13	SMA	5,000/Tape & Reel	NRND	B350A-13-F
B360AE-13	SMA	5,000/Tape & Reel	Active	—

- Notes:
1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.
 5. NRND: Not recommended for new design.

Marking Information



B3XXAE = Product Type Marking Code, ex: B350AE
 ☺ = Manufacturers' Marking
 YWW = Date Code Marking
 Y = Last Digit of Year (ex: 0 for 2020)
 WW = Week Code (01 to 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristic	Symbol	B350AE	B360AE	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	50	60	V
Working Peak Reverse Voltage	V _{RWM}			
DC Blocking Voltage	V _{RM}			
Average Rectified Output Current	I _O	3		A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	80		A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 6)	R _{θJA}	60	°C/W
Typical Thermal Resistance Junction to Case (Note 6)	R _{θJC}	30	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop	V _F	—	0.55 0.52	0.65 —	V	I _F = 3A, T _J = +25°C I _F = 3A, T _J = +125°C
Leakage Current (Note 7)	B350AE B360AE I _R	—	— 25	0.1 0.2 —	mA	V _R = 50V, T _J = +25°C V _R = 60V, T _J = +25°C V _R = 60V, T _J = +125°C
Typical Capacitance	C _T	—	125	—	pF	V _R = 4.0V, f = 1MHz

Notes: 6. Device mounted on FR-4 substate, 1"×1", 2oz, single-sided, PC boards with 0.56"×0.73" copper pad.
7. Short duration pulse test used to minimize self-heating effect.

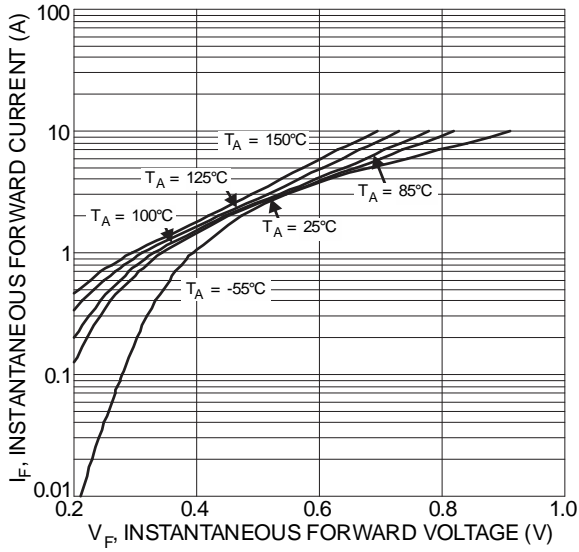


Figure 1 Typical Forward Characteristics

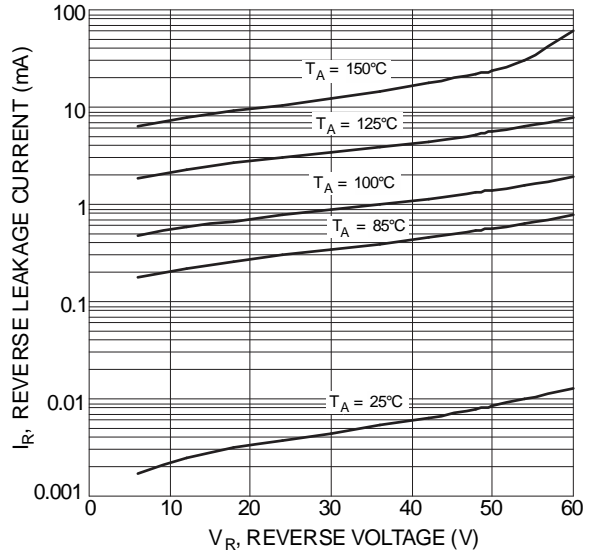


Figure 2 Typical Reverse Characteristics

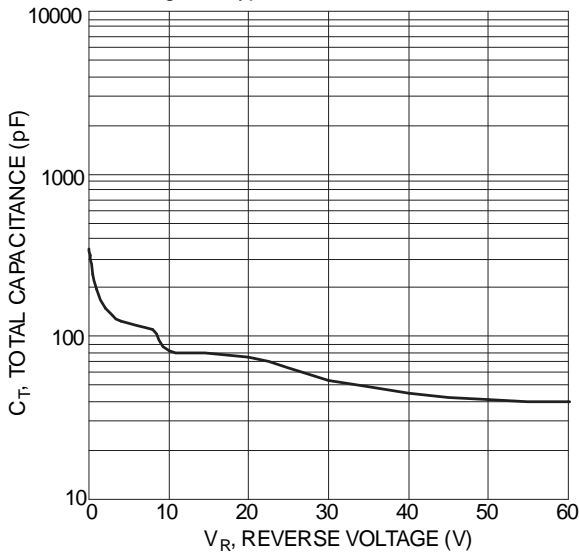


Figure 3 Total Junction Capacitance

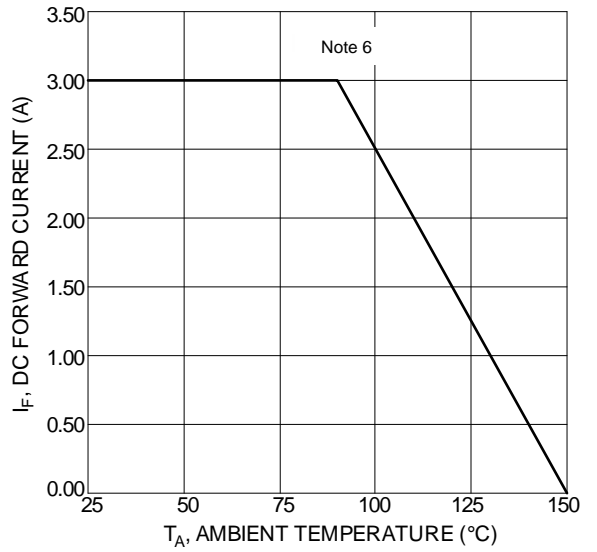
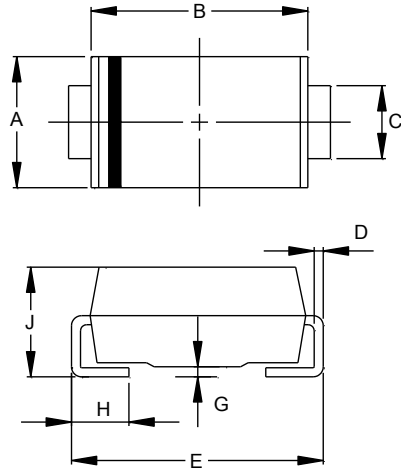


Figure 4 DC Forward Current Derating Curve

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SMA

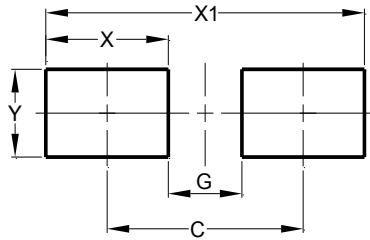


SMA		
Dim	Min	Max
A	2.29	2.92
B	4.00	4.60
C	1.27	1.63
D	0.15	0.31
E	4.80	5.59
G	0.05	0.20
H	0.76	1.52
J	1.96	2.40
All Dimensions in mm		

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SMA



Dimensions	Value (in mm)
C	4.00
G	1.50
X	2.50
X1	6.50
Y	1.70

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